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# Design Technologies for Energy-Efficient VLSI Systems

Final Progress Report

Prof. Marios C. Papaefthymiou, Principal Investigator

20 January 2007

U.S. Army Research Office

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# 1 Statement of the problems studied

This project has investigated novel design technologies for energy-efficient VLSI systems. Its primary focus has been on charge-recovery circuits. These circuits achieve higher energy efficiency than their conventional counterparts by steering currents to flow across devices with low voltage drops, while recycling undissipated energy in parasitic capacitors. Previous investigations into charge recovery have resulted in complex circuits and architectures that are impractical for high-speed design. This project has led to the discovery of practical low-complexity charge-recovery circuits which achieve high energy efficiency and achieve clock frequencies in excess of 1GHz. The results of this research have been validated through silicon prototyping and experimentation. For four of the inventions resulting from this project, the University of Michigan has filed utility and provisional patent applications with the US Patent and Trademark Office.

# 2 Summary of the most important findings

The main contributions of this research project were the following.

- **Boost Logic for GHz charge-recovery operation:** Boost logic is a novel dynamic charge-recovery family that operates with a two-phase power-clock waveform. In post-layout Spice simulations of 16-bit multipliers in a 130nm bulk silicon process at 1GHz, Boost Logic implementations achieve 5-10 times higher energy efficiency than minimum-energy pipelined and voltage-scaled static CMOS at the expense of 2-3 times longer latency. In a fully-integrated test chip implemented using a 130nm bulk silicon process and on-chip inductors, chains of Boost Logic gates operate at clock frequencies up to 1.3GHz with a 1.5V supply. When resonating at 850MHz with a 1.2V supply, the Boost Logic test chip achieves 60% charge recovery. This Boost Logic is the fastest charge-recovery design reported to date.
- **Charge-recovery ASIC design methodology:** This ASIC methodology relies on a novel charge-recovery flip-flop design and a metal-only clock distribution network. By enabling the recovery of charge from the clock distribution network, this methodology yields ASIC designs with minimal clock power dissipation. A resonant-clocked ASIC for the Discrete Wavelet Transform has been designed using this methodology and industry-standard tools. On-chip circuitry is used to generate a single-phase resonant clock of sinusoidal shape. Correct operation has been confirmed experimentally for clock frequencies up to 300MHz, with measured clock power savings ranging between 60% and 75% at 15MHz, depending on primary input activity.
- **GHz-class resonant clocking:** The potential of resonant clocking for energy efficient design at GHz-class operating frequencies has been evaluated through chip measurements of a 1.1GHz resonant clock distribution network in a 130nm bulk silicon process. Energy savings in the order of 45% have been demonstrated.
- **Low-power charge-recovery static memory (SRAMs):** The proposed SRAM architecture relies on balanced loading to achieve high-efficiency charge recovery from

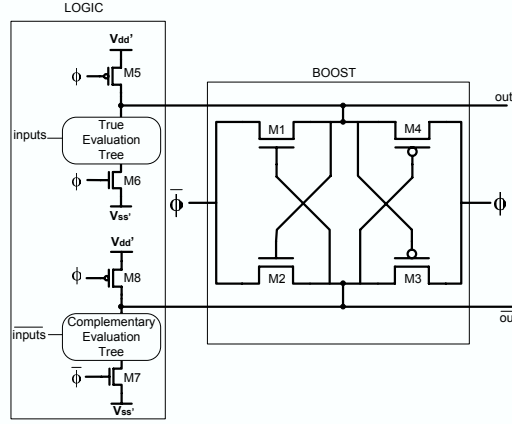


Figure 1: Schematic of Boost logic gate with pseudo-NMOS pulldown.

the bit lines. In Spice simulations of SRAM arrays in a 250nm bulk silicon process, the proposed architecture dissipates 27% less power than its conventional counterpart.

The remainder of this section provides more details about each of our main contributions.

## 2.1 Boost Logic

Charge-recovery architectures reduce energy dissipation by steering currents across devices with low voltage differences while recycling the energy stored in their capacitors [1, 4]. The efficient operation of these designs is the result of an energy-speed trade-off. This project has led to the discovery of Boost Logic, a high-speed charge-recovery circuit family that is capable of operating at GHz-class frequencies with high efficiency by trading off power dissipation for latency of operation [11, 12, 13, 14].

Boost Logic achieves significant energy savings over voltage-scaled static CMOS across a range of frequencies much higher than previously demonstrated in charge-recovery literature. A unique feature of Boost Logic that enables energy-efficient and high-throughput operation is an aggressively scaled, conventionally switching “Logic” stage that operates in tandem with a charge-recovery “Boost” stage. Logic performs the logical evaluation of a Boost Logic gate operating at an ultra-low DC supply voltage of approximately one threshold voltage  $V_{th}$ . After Logic pre-resolves the differential outputs of a Boost Logic gate to the level of about one threshold voltage, Boost amplifies the difference between the output nodes to the full rail in an energy-efficient charge-recovery manner, providing a large overdrive to fanout gates and thereby reducing delay in their Logic stages.

Figure 1 shows the structure of a Boost Logic gate. The Logic stage can be implemented in any transistor topology as long as it supports the use of clocked transistors M5–M8. These clocked transistors decouple the Logic stage from the output nodes when the Boost stage drives them. The pseudo-NMOS implementation shown in Figure 1 trades off the voltage difference in the pre-resolved output nodes (pseudo-NMOS gates do not swing to the full rail) for lower gate loading to achieve better performance at higher operating frequencies. At lower operating frequencies, the use of dual-rail CMOS topology in

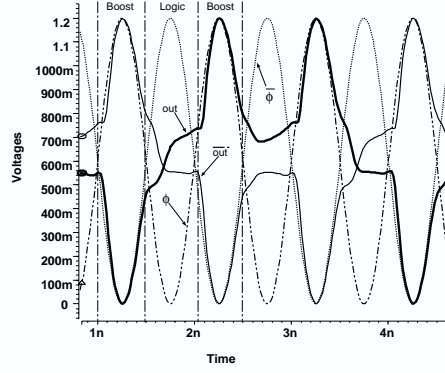


Figure 2: Simulation waveform of Boost Logic inverter.

Logic offers the advantages of full-rail evaluation, the lack of crowbar current, and reduced susceptibility to process variation. The DC power-supply rails are at voltages

$$V'_{dd} = \frac{1}{2} \cdot (V_{dd} + V_{th})$$

$$V'_{ss} = \frac{1}{2} \cdot (V_{dd} - V_{th})$$

Therefore, the potential difference between the supply rails in Logic is  $V_{th}$ . The Boost stage resembles back-to-back inverters, with the only difference being that  $V_{dd}$  and  $Gnd$  are replaced by  $\phi$  and  $\bar{\phi}$ .

Figure 2 shows the outputs of an inverter in a ring configuration of four Boost Logic inverters. During Logic, an initial potential difference is developed between the two complementary outputs. During Boost, Logic is deactivated, and the power-clock waveforms drive the outputs to the rails ( $V_{dd}$  or  $Gnd$ ). These outputs in turn drive fanout Logic stages. As the power-clock phases swing back and their voltage difference approaches  $V_{th}$ , the transistors in the Boost stage are in cutoff, isolating Boost from the outputs. At that time, Logic once again begins to evaluate.

To compare the performance of Boost Logic designs with their conventional counterparts, we designed 16-bit carry-save multipliers in static CMOS and Boost Logic using a 130nm bulk silicon process. In the Boost multiplier, a two-phase power-clock waveform was obtained using an H-Bridge clock generator. The clock generator was driven at the target clock frequency of 1GHz. The inductor value was set at  $L = 2.55nH$ , so that the natural frequency of the LC system formed by the parasitic capacitance of the circuit and the inductor of the clock generator matched the target operating frequency of 1GHz. The static CMOS multiplier was pipelined and voltage-scaled for minimum power, achieving 1GHz operation with a 1V supply and 8 cycles of latency. With regular  $V_{th}$ , the latency of the Boost multiplier was 3 times longer (24 cycles), but its energy efficiency was 5 times higher (15.8pJ vs. 80.1pJ per cycle). With low  $V_{th}$ , the latency of the Boost multiplier was 2 times longer (16 cycles), while its energy efficiency was almost 10 times higher (10.64pJ vs. 80.1pJ per cycle).

In a fully integrated test-chip we implemented using a 130nm bulk silicon process and

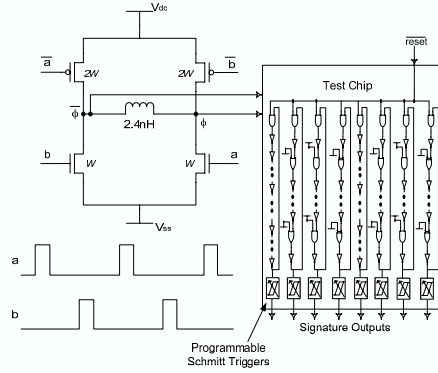


Figure 3: Block diagram of Boost Logic test chip.

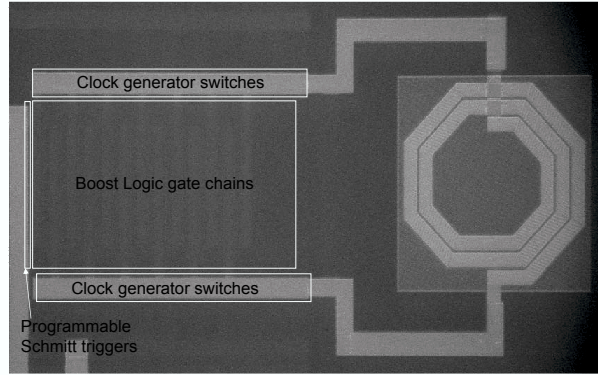


Figure 4: Microphotograph of Boost Logic test chip.

on-chip inductors, chains of Boost Logic gates operate at clock frequencies up to 1.3GHz with a 1.5V supply. Figure 3 shows a block diagram and Figure 4 shows a microphotograph of our test chip. The test structures on the chip were 8 chains of AND, OR, XOR, and INV gates. Each chain had 200 gates. An on-chip H-Bridge clock generator was used with a 2.4nH on-chip inductor. The four clock generator switches were driven at the target clock frequency.

Figure 5 gives measured current and inferred power dissipation in the  $V_{dd}$  supply of the test chip over a range of operating frequencies from 700MHz to 1.1GHz. Correct operation was verified up to 1.3GHz. The natural frequency of the chip was measured at approximately 850MHz. At that frequency, energy per cycle was measured at 26pJ, yielding a 60% reduction in power dissipation over  $CV^2$  switching of the same capacitive load.

## 2.2 Charge-recovery ASIC design

Another significant contribution of this project has been the development of an ASIC methodology for charge-recovery design. This methodology relies on a flip-flop archi-

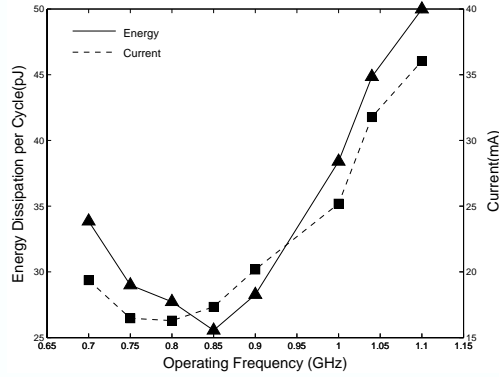


Figure 5: Measured current and corresponding per-cycle energy vs. frequency.

tecture that can operate with a sinusoidal clock to yield a resonant-clocked ASIC with a metal-only clock distribution network.

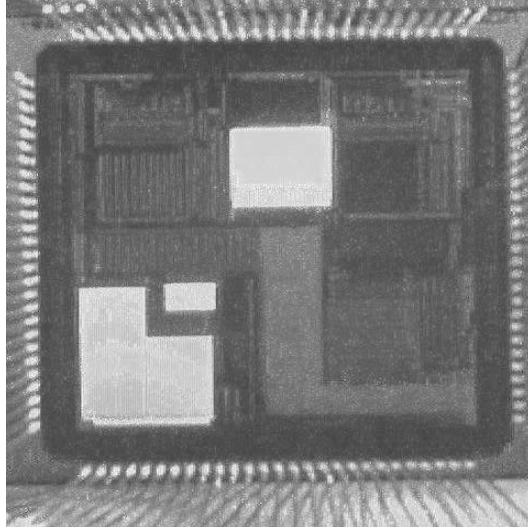


Figure 6: Microphotograph of the resonant clocked ASIC chip.

To demonstrate the effectiveness of our charge-recovery ASIC design methodology, we have designed and tested a synthesized ASIC that performs a 7-bit Discrete Wavelet Transform. The chip has been fabricated in a 250nm bulk-CMOS process through MOSIS. Comprising close to 4,000 gates, our ASIC is clocked by a resonant charge-recovering waveform of sinusoidal shape. Figure 6 shows a microphotograph of our resonant-clocked chip [17]. The lower left corner of the die contains our experimental energy-recovering design that consists of an ASIC core, an on-chip resonant clock generator, and some testing logic. The energy recovering flip-flops are driven by a resonant waveform generated using an off-chip surface-mount inductor and the on-chip power-clock generator.

A schematic of the energy-recovering flip-flop used in our ASIC is shown in Figure 7. This flip-flop consists of a charge-recovery dynamic buffer that drives a pair of cross-



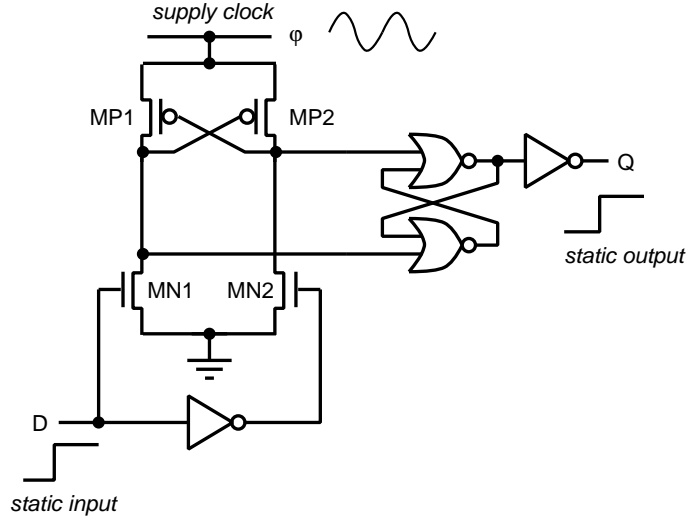


Figure 7: Energy recovering sinusoidal flip-flop used in the resonant clocked ASIC chip.

coupled NOR gates as the static latch element. Our flip-flop latches on rising pulses of power-clock. The input needs to be stable by the time power-clock is roughly half way to its peak, and should be held stable until power-clock is at the peak. The flip-flop draws more current from the power-clock when active (i.e., the data is changing), thus changing the effective load seen by the power-clock generator.

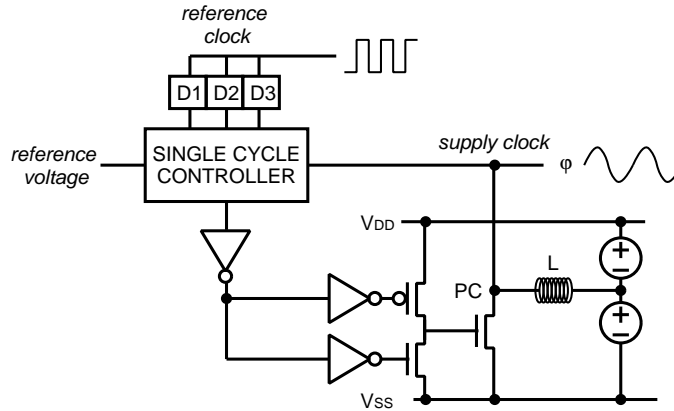


Figure 8: Clock generator used in ASIC chip.

Our chip includes a single-cycle feedback control resonant power-clock generator, shown in Figure 8, that is capable of reacting to changes in its load. The amplitude of the power-clock signal is sampled and compared against a reference level. The result of this comparison is used to decide, on a cycle-by-cycle basis, whether or not to turn on the main NMOS power-switch to pump more energy into the power-clock. This control is critical for achieving ultra-low dissipation when the ASIC is idling.

Figure 9 shows the measured energy dissipation of the clock network in our resonant-clocked ASIC chip at several frequencies between 100MHz and 300MHz. At each frequency point, the voltage was scaled down to the minimum required for correct operation.

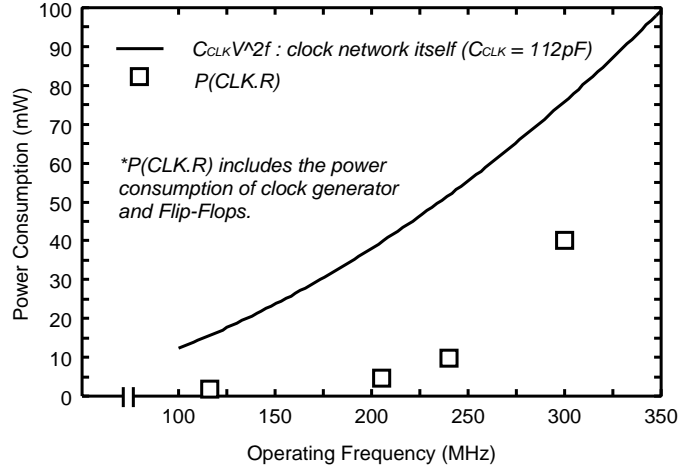


Figure 9: Measured power consumption resonant-clocked ASIC.

The inductor and DC supplies were connected externally. For reference, we plot a quadratic curve fit to the function  $f C V_{dd}^2$  evaluated at each of the voltage, frequency pairs. This curve represents the dissipation required to drive the same clock capacitance if charge recovery techniques were not used. At  $f=300\text{MHz}$ , the clock was overdriven using an inductance value larger than  $1/C(2\pi\omega)^2$ , resulting in suboptimal power dissipation at that frequency. At  $205\text{MHz}$ , the measured clock power dissipation was  $4.5\text{mW}$ , about 5 times less than required to drive the same clock capacitance with conventional means. These dramatic power savings are due to operation near the resonance of the inductor in conjunction with the clock-capacitance.

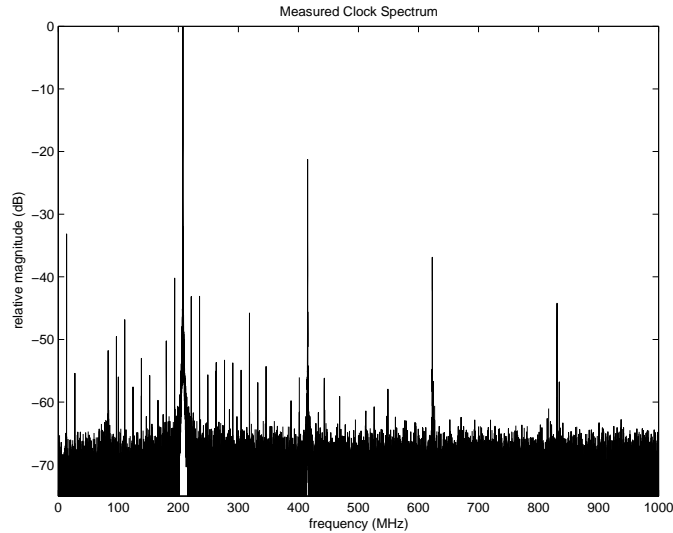


Figure 10: Measured power-clock spectrum at 200MHz.

In addition to reduced power dissipation, charge recovery circuitry has the potential to operate with substantially reduced electromagnetic interference. To provide empirical evidence in support of this largely unexplored fact, we analyzed the spectrum of the measured

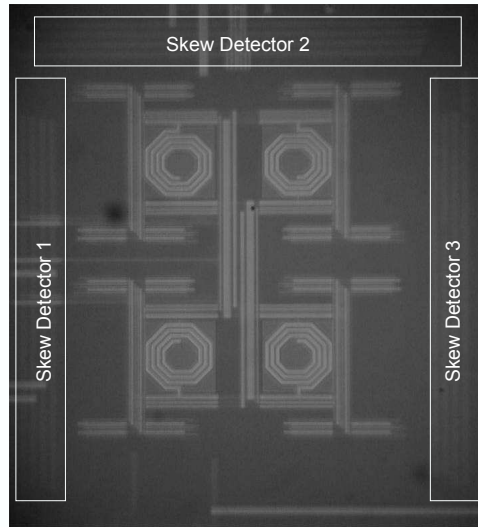


Figure 11: Microphotograph of GHz resonant clock distribution test chip.

power-clock waveform when resonating at 200MHz. The spectrum obtained is shown in Figure 10, zoomed in on the region of interest from 0 to 1GHz. This data was obtained by recording 100,000 voltage samples at 100ps/sample at the off-chip inductor terminal. Assuming linear characteristics from the parasitic elements between the inductor terminal and the on-chip clock network, this data should be proportional to the actual clock signal on-chip. The graph shows the presence of substantially attenuated odd and even harmonics. Specifically, the first 3 harmonics are 22dB, 36dB, and 43dB below the fundamental, respectively. In contrast, the first harmonic of a square waveform at 600MHz is about 12dB below the fundamental. The spur at roughly 10MHz could be attributed to a periodicity in the datapath self-test activity, as it corresponds roughly to the spectrum of one of the self-test signature outputs. An alternate hypothesis is that it results from some coupling with one of the I/O pads slewing.

### 2.3 GHz-class resonant clocking

Resonant clock distribution has the potential to reduce clock power and achieve low clock skew and jitter [3]. In this project, a two-phase resonant clock network with a programmable driver and loading has been designed and evaluated. This network uses a clock generator that is driven at a reference clock frequency. It also uses the size and duty cycle of the replenishing switches in the clock generator to adjust clock amplitude. Programmable loading allows for different balanced/imbalanced load configurations, enabling the investigation of clock amplitude, power, and skew at resonance and off resonance for operating frequencies in the 900MHz to 1.2GHz range. Included is on-chip circuitry for measuring skew and clock amplitude.

Figure 2.3 gives a microphotograph of our resonant-clocked test chip. 4nH spiral inductors connected in parallel are placed symmetrically around the center of the H-tree clock network. A single central H-bridge clock generator is used to compensate for power losses and maintain clock amplitude using switches of programmable size that are driven by re-

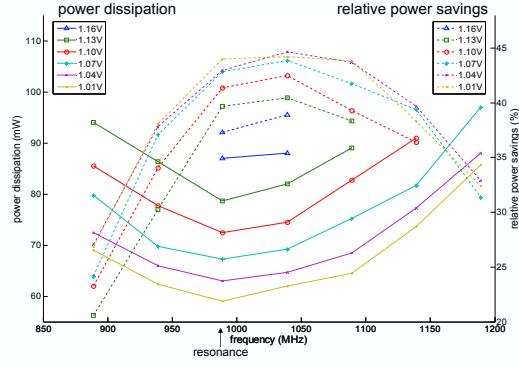


Figure 12: Measured total power dissipation and efficiency vs. frequency.

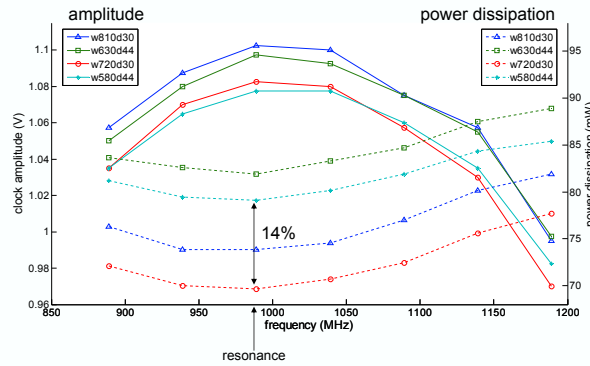


Figure 13: Measured power dissipation and clock amplitude vs. frequency.

plenishing pulses of programmable duty cycle.

Figure 2.3 gives measured total power dissipation as a function of operating frequency. All data are obtained with a total capacitance of approximately 52pF per phase, yielding a resonant frequency of 990MHz. For each data point, switch size and duty cycle have been chosen to yield minimum power dissipation at the corresponding operating frequency while maintaining the same average amplitude over all 16 leaf nodes in the network. The curves report average results for 4 test chips. The maximum difference in measured amplitude and power among the 4 chips is less than 6%. Power dissipation is minimized when the system is driven at its resonant frequency. Maximum relative power savings of the resonant clock system over conventional  $CV^2$  are in the 45% range.

Figure 2.3 gives measured clock amplitude and power dissipation as functions of frequency for four switch size/duty cycle configurations (average from 4 test chips). The results show that configurations with larger switch size and smaller replenishing duty cycle can dissipate less power, while maintaining the same amplitude. When driving frequency is 10% off resonance at 1.1GHz, power dissipation increases by 3(720 $\mu$ m, 30 than the (580 $\mu$ m, 44(630 $\mu$ m, 44 results. In general, larger switches reduce resistance in the clock generator and increase clock amplitude. Smaller duty cycle reduces current from Vdd to Vss, hence lowering power dissipation.

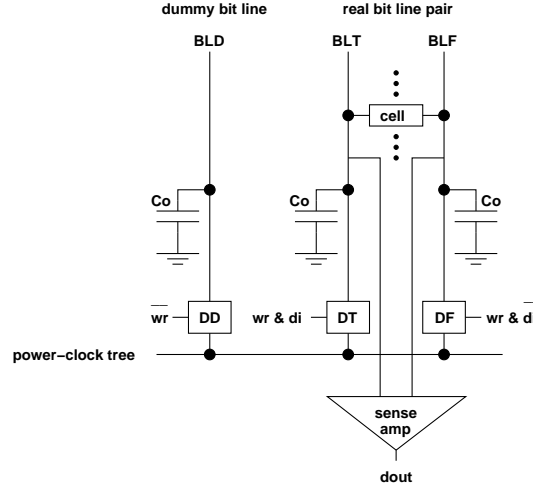


Figure 14: CLM column with dummy bit-line and charge recovery.

## 2.4 Charge-recovery SRAM

The application of energy recovery to memory design is particularly compelling, due to the substantial switching capacitance in memory arrays. Early work on energy recovery memories has used multiple power-clocks [15, 9, 2, 8, 10, 16], resulting in designs with multiple-cycle latency and limited scalability. Low-complexity energy recovery memories with a single-phase power-clock have been reported in [7, 6]. These memories exhibit data/operation-dependent variations in the capacitive load presented to the power-clock, however, resulting in limited energy efficiency due to poor resonance.

In this project, we have explored CLM, an energy recovery SRAM architecture that presents a constant capacitive load to the power-clock, regardless of memory operations or data access patterns [5]. In CLM, non-selective precharge is used to ensure a constant memory load during write operations, regardless of data pattern. Furthermore, when bit lines are disconnected from the power-clock during nonwrite cycles, dummy bit lines of equal capacitance are connected to the power-clock, maintaining a constant memory load. CLM provides single-cycle operations using a single-phase power-clock for low complexity and efficient high-speed operation.

A schematic diagram of a bit-line in the proposed constant-load charge-recovery memory is shown in Figure 14. In this design, each bit-line pair BLT and BLF is “shadowed” by a dummy bit-line. Each bit-line is selectively connected to the column memory cells and a sense amplifier. The dummy bit-line has no connection with the column cells or the sense amplifier, however. During each write cycle, exactly one of the drivers turns on, transferring charge between the system inductor and exactly one of the bit-lines BLT or BLF, respectively. During each non-write cycle, the driver DD turns on, connecting the dummy bit-line with the power-clock. The dummy bit-line is designed so that it presents approximately the same load on the power-clock as an actual bit-line. Thus, the load of the power-clock remains constant during write and non-write cycles, maintaining a constant amplitude and maximizing energy efficiency.

To assess the performance of our proposed energy recovery SRAM architecture, we have designed a  $128 \times 256$  SRAM using a 250nm bulk silicon process. In Spice simulations with a 2.5V supply, CLM functions correctly at clock frequencies up to 400MHz. Using an ideal power-clock waveform, CLM achieves power reductions in excess of 37% over its conventional counterpart with a 42/58 write/non-write operation mix. Assuming lossless power-clock generation, the proposed SRAM dissipates 38% less power than its conventional counterpart at 400MHz, 2.5V. When the power dissipation of the power-clock generator is taken into account, overall power savings are 27%.

### 3 List of publications and technical reports

#### 3.1 Papers published in peer-reviewed journals

- V. S. Sathe, J.-Y. Chueh, and M. C. Papaefthymiou. Energy-efficient GHz-class charge-recovery logic. *IEEE Journal of Solid State Circuits*, Vol. 42, No. 1, January 2007.
- X. Liu, Y. Peng, and M. C. Papaefthymiou. Practical repeater insertion for low power: What repeater library do we need? *IEEE Transactions on Computer-Aided Design of Integrated Circuits*, Vol. 25, No. 5, pp. 917-924, May 2006.
- X. Liu and M. C. Papaefthymiou. HyPE: Hybrid power estimation for IP-based systems-on-chip. *IEEE Transactions on Computer-Aided Design of Integrated Circuits*, Vol. 24, No. 7, pp. 1089–1103, July 2005.
- S. Kim, C. Ziesler, and M. C. Papaefthymiou. Charge-recovery computing on silicon. *IEEE Transactions on Computers*, Vol. 54, No. 6, June 2005.
- X. Liu and M. C. Papaefthymiou. A Markov chain sequence generator for power macromodeling. *IEEE Transactions on Computer-Aided Design of Integrated Circuits*, Vol. 23, No. 7, pp. 1048–1062, July 2004.
- J. Kim and M. C. Papaefthymiou. Block-based multi-period refresh for energy efficient dynamic memory. *IEEE Transactions on VLSI Systems*, Vol. 11, No. 6, pp. 1006–1018, December 2003.
- X. Liu and M. C. Papaefthymiou. Design of a 20 Mb/s 256-state Viterbi decoder. *IEEE Transactions on VLSI Systems*, Vol. 11, No. 6, pp. 965–975, December 2003.
- S. Kim, C. Ziesler, and M. C. Papaefthymiou. Fine-grain real-time reconfigurable pipelining. *IBM Journal of Research and Development*, Vol. 47, No. 5/6, pp. 599–609, September/November 2003.

### 3.2 Papers published in non-peer-reviewed journals or in conference proceedings

- J.-Y. Chueh, V. Sathe, and M. C. Papaefthymiou. 900MHz to 1.2GHz two-phase resonant clock network with programmable driver and loading. In *IEEE 2006 Custom Integrated Circuits Conference*, September 2006.
- V. Sathe, J.-Y. Chueh, and M. C. Papaefthymiou. A 1.1GHz charge recovery logic. In *International Solid-State Circuits Conference*, February 2006.
- V. Sathe, C. Ziesler, and M. C. Papaefthymiou. GHz-class charge recovery logic. In *International Symposium on Low-Power Electronics and Design*, August 2005.
- V. Sathe, J.-Y. Chueh, J. Kim, C. Ziesler, S. Kim, and M. C. Papaefthymiou. Fast, efficient, recovering, and irreversible. In *1st Workshop on Reversible Computing* of the 2005 ACM Computing Frontiers Conference, May 2005.
- J.-Y. Chueh, V. Sathe, and M. C. Papaefthymiou. Two-phase resonant clock distribution. In *Proceedings of the 2005 IEEE International Symposium on VLSI*, May 2005.
- V. Sathe, M. C. Papaefthymiou, and C. Ziesler. Boost Logic: A high-speed energy recovery circuit family. In *Proceedings of the 2005 IEEE International Symposium on VLSI*, May 2005.
- X. Liu, Y. Peng, and M. C. Papaefthymiou. RIP: An efficient hybrid repater insertion scheme for low power. In *Proceedings of the 2005 Conference on Design, Automation, and Test in Europe*, March 2005.
- V. S. Sathe, C. H. Ziesler, M. C. Papaefthymiou, S. Kim, and S. Kosonocky. A synchronous interface for SoCs with multiple voltage and clock domains. In *17th IEEE International SOC Conference*, September 2004.
- D. Velenis, E. G. Friedman, and M. C. Papaefthymiou. Clock tree layout design for reduced delay uncertainty. In *17th IEEE International SOC Conference*, September 2004.
- J. Kim and M. C. Papaefthymiou. Constant-load energy recovery memory for efficient high-speed operation. In *International Symposium on Low-Power Electronics and Design*, August 2004.
- X. Liu, Y. Peng, and M. C. Papaefthymiou. Practical repeater insertion for low power: What repeater library do we need? In *Proceedings of the 41st ACM/IEEE Design Automation Conference*, June 2004.
- J.-Y. Chueh, C. Ziesler, and M. C. Papaefthymiou. Empirical evaluation of timing and power in resonant clock distribution. In *2004 IEEE International Symposium on Circuits and Systems*, May 2004.

- J. Kim, M. C. Papaefthymiou, and A. Tayyab. An algorithm for geometric load balancing with two constraints. In *Proceedings of the 18th International Parallel and Distributed Processing Symposium*, April 2004.
- J.-Y. Chueh, C. Ziesler, and M. C. Papaefthymiou. Experimental evaluation of resonant clock distribution. In *Proceedings of the 2004 IEEE International Symposium on VLSI*, February 2004.
- C. Ziesler, J. Kim, V. Sathe, and M. C. Papaefthymiou. A 225MHz resonant clocked ASIC chip. In *International Symposium on Low Power Electronics and Design*, August 2003.

### **3.3 Papers presented at meetings but not published in conference proceedings**

N/A

### **3.4 Manuscripts submitted but not published**

- V. Sathe, J. Kao, and M. C. Papaefthymiou. A 1.2GHz resonant-clocked 8-bit 14-tap FIR filter.

### **3.5 Technical reports submitted to ARO**

N/A

## **4 List of all participating research personnel**

Prof. Marios C. Papaefthymiou, PI

- Promoted to Professor of Electrical Engineering and Computer Science, effective September 2005.
- Director, Advanced Computer Architecture Laboratory, University of Michigan, September 2000–present.

Conrad Ziesler, Graduate Research Assistant.

- Ph.D., April 2004. Ziesler declined an Assistant Professor position at the University of Minnesota to join a West Coast startup. He is currently with PA Semi, Inc.

Joohee Kim, Graduate Research Assistant.

- Ph.D., August 2004. Kim assumed a position with Hynix Corporation.

Juang-Ying Chueh, Graduate Research Assistant.

- Ph.D., April 2006. Chueh assumed a position with AMD Corporation.

Visvesh Sathe, Graduate Research Assistant.

Sujay Phadke, Graduate Research Assistant.



## 5 Report of inventions

The following inventions were disclosed to the University of Michigan. Patent applications were filed as indicated. These inventions have been exclusively licensed by Cyclos Semiconductor, a venture-backed startup that commercializes ultra-low-power semiconductor technologies.

- Clock distribution network architecture for resonant clocked systems. File No. 3531, University of Michigan Technology Transfer Office, October 2006. US Provisional Patent Application, December 2006.
- Energy-recovering low-swing low-activity data bus. File No. 2929, University of Michigan Technology Transfer Office, August 2004.
- Automatic synchronization of resonant and legacy clock domains. File No. 2928, University of Michigan Technology Transfer Office, August 2004.
- Dual-frequency resonant clocking. File No. 2927, University of Michigan Technology Transfer Office, August 2004.
- Dynamic frequency and voltage scaling of resonant clocks. File No. 2926, University of Michigan Technology Transfer Office, August 2004.
- Energy recovery boost logic. File No. 2833, University of Michigan Technology Transfer Office, March 2004. US Provisional Patent Application, June 2004. US Patent Application, June 2005.
- Automatic tuning system for resonant clock generator. File No. 2803, University of Michigan Technology Transfer Office, February 2004. US Provisional Patent Application, June 2004.
- Low power flip-flop with gate enable and scan chain enable. File No. 2802, University of Michigan Technology Transfer Office, June 2004. US Provisional Patent Application, October 2005. US Patent Application entitled “Ramped clock digital storage control” was filed October 2006.

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